



## Agreement for Exchange of Confidential Information

### Supplement for Disclosure

---

**Agreement number:** C04059

**Supplement number:** X32654

**Discloser:** IBM - X

**Initial Disclosure Date:** February 28, 2006

**Final Disclosure Date:** February 27, 2009

*Initial Disclosure Date is the actual date of disclosure or the date on which access to Information, such as may be contained in a database, is to be initiated. Information described below becomes subject to the referenced Agreement and any additional terms contained herein on this date. Final Disclosure Date is the date on which the disclosure is to be completed or the date on which access to Information will be terminated.*

#### **Confidential Information:**

*The following is a non-confidential description of Information the Discloser wishes to disclose.*

##### **From IBM:**

Business and technical information regarding Foundry CMOS 6SF, CMOS 8SF and CMOS 8RF technologies, including documentation, manuals, ground rules, design flow, electrical characterization information, datasheets (or catalogs), product road maps, design kit information, model information, design information, device circuit design and related technical data.

##### **From Physikalisches Institut der Universität Heidelberg:**

None.

#### **Additional terms, if any:**

*Each of us agrees to modify the referenced Agreement, for disclosures of Information described above, as follows.*

The following sentence shall be added to the end of Section 1. Disclosure.

"If any information is disclosed orally, the Discloser shall promptly provide to the Recipient a written summary".

In Section 2. Obligations, delete item 2. following "The Recipient agrees to:" and replace with

"2. use the Discloser's Information only for the evaluation, design and/or manufacture of products by IBM or to assist an IBM customer in the design of such products."

In Section 2. Obligations, item 1. following "The Recipient may disclose Information to:" delete "its employees who have a need to know, and employees of" and replace with "its employees and contractors who have a need to know, and employees and contractors of".

Disclosures made after the **Initial Disclosure Date** and prior to the last signature date on this Supplement shall be subject to the terms and conditions of this Agreement.

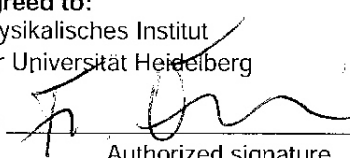
Both of us agree that the IBM Agreement for Exchange of Confidential Information and this Supplement contain our complete and exclusive agreement regarding this disclosure and replace any prior oral or written communications between us. If there is a conflict among terms, those of this Supplement prevail over those of the Agreement. Any reproduction of this Supplement made by reliable means (for example, photocopy or facsimile) is considered an original.

**The only time both of us are required to sign is when additional terms are included.**

**Agreed to:**

Physikalisches Institut  
der Universität Heidelberg

By

  
Authorized signature

**Name (type or print):**

FRANZ EISELE

**Title:**

Prof.

**Date:**

21.03.06

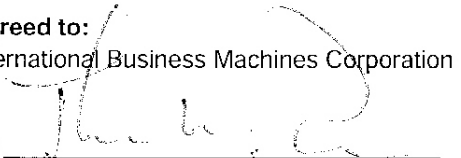
**Address:**

Philosophenweg 12  
69120 Heidelberg  
GERMANY

**Agreed to:**

International Business Machines Corporation

By

  
Authorized signature

**Name (type or print):**

VP Semiconductor Prod & Solutions

**Title:**

**Date:**

March 30 2006

**Agreement number:** C04059

**IBM address:**

IBM TG WW Contracts Administration  
Ch. de Blandonnet 8  
1214 Vernier, Geneva  
SWITZERLAND

After signing, please return a copy of this Agreement to the "IBM address" shown above.